WIDE BAND MULTILAYER CERAMIC ANTENNA FOR 850~950MHz

Product Specification¹ (**Preliminary**)

QUICK REFERENCE DATA

Size 16.5*14*0.9 mm

Working Frequency 850~950MHz

Gain 1.5 dBi Max

VSWR 2 max

Polarization Linear

Azimuth Omni-directional

Impedance 50Ω

Operating Temperature -55~125 °C

Termination Ni/Sn (Environmentally-Friendly Leadless)

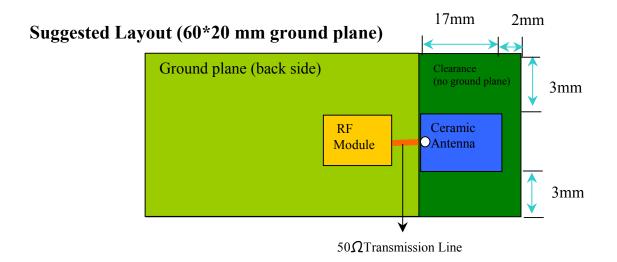
Resistance to soldering heats 260°C, 10 sec.

Special Environmental Concerns- Green Products Design: The foil making process is using environmentally friendly aqueous solvent technology. Termination is lead free and packing materials can be re-cycled

¹ All the technical data and information contained herein are subject to change without prior notice

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|--------------|---------------------|--|--------|------------------------------------|-------------|--|--|
| | | | | | Mar. 13, 02 | | |
| | | Multilayer Ceramic Antenna (LP Mode) for 850~950MHz | | 4311 119 00087 AN0870000716141B | | | |
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APPLICATION



Solder Land Pattern for Antenna

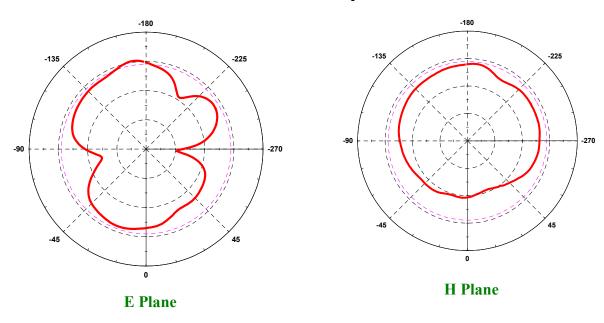
| Figure | | Dimensions | Remark |
|---|----|-----------------------------|-----------|
| L | L | $17.00 \pm 0.10 \text{ mm}$ | |
| $\begin{array}{ c c c c c c c c c c c c c c c c c c c$ | W | 14.40 ± 0.10 mm | |
| S1 $S1$ | F | $1.00 \pm 0.10 \text{ mm}$ | Feed pad |
| F \bigcirc | С | $0.90 \pm 0.10 \text{ mm}$ | |
| S1 $S1$ | S1 | $1.40 \pm 0.10 \text{ mm}$ | Mount pad |
| | S2 | $1.00 \pm 0.10 \text{ mm}$ | Mount pad |

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| | (LF Wiode) for 850~ | | | | | | | |
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MECHANICAL DATA

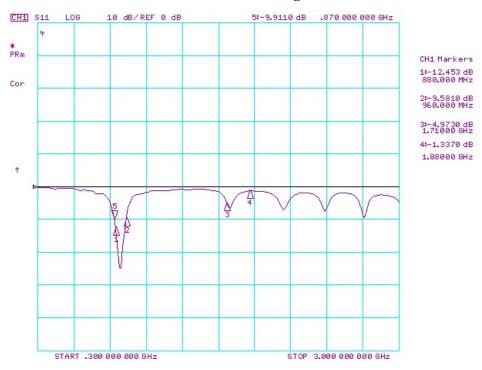
| Figure | Dimension | Port |
|---|--|------|
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | L 16.5±0.5mm W 14.0±0.5mm T 0.9±0.2mm F 2.1±0.25mm C 1.0±0.3mm S1 1.70±0.35mm 2.1±0.25mm | |

Radiation Pattern Polar plot

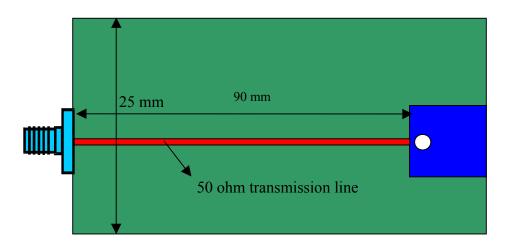


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| | Multilayer Ceramic (LP Mode) for 850~ | | 4311 11 AN0870 | Mar. 13, 02 Oct. 14, 02 | | |
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Return Loss Signal



DEMO Board



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| | Multilayer Cerami (LP Mode) for 850 | | 4311 11 AN087 | Mar. 13, 02 Oct. 14, 02 | | | |
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RELIABILITY DATA (Reference to IEC Specification)

| IEC 384-10/ CECC 32 100 CLAUSE | IEC 6006868-2 TEST METHOD | TEST | PROCEDURE | REQUIREMENTS |
|--|------------------------------------|---------------------------------------|---|---|
| 4.4 | | Mounting | The antenna can be mounted on printed-circuit boards or ceramic substrates by applying wave soldering, reflow soldering (including vapour phase soldering) or conductive adhesive | No visible damage |
| 4.5 | | Visual inspection and dimension check | Any applicable method using × 10 magnification | In accordance with specification (no chip off 3 mm) |
| 4.6.1 | | Antenna | Central Frequency at 20 °C | Standard test board in page 4 |
| 4.8 | | Adhesion | A force of 5 N applied for 10 s to the line joining the terminations and in a plane parallel to the substrate | No visible damage |
| 4.9 | | Bond strength of plating on end face | Mounted in accordance with CECC 32 100, paragraph 4.4 | No visible damage |
| | | | Conditions: bending 0.25 mm at a rate of 1mm/s, radius jig. 340 mm,1 mm warp on FR4 board of 90 mm length | No visible damage |

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| IEC 384-10/ CECC 32 100 CLAUSE | IEC 6006868-2 TEST METHOD | TEST | PROCEDURE | REQUIREMENTS |
|--|------------------------------------|------------------------------|--|---|
| 4.10 | Tb | Resistance to soldering heat | 260 ± 5 °C for 10 ± 0.5 s in a static solder bath | The terminations shall be well tinned after recovery and Central Freq. Change ± 6% |
| | | Resistance to leaching | 260 ± 5 °C for 30 ± 1 s in a static solder bath | Using visual enlargement of × 10, dissolution of the termination shall not exceed 10% |
| 4.11 | Та | Solderability | Zero hour test, and test after storage (20 to 24 months) in original atmosphere; un-mounted chips completely immersed for 2 ± 0.5 s in 235 ± 5 °C. | The termination must be well tinned, at least 75% is well tinned at termination |
| 4.12 | Na | Rapid change of temperature | -55 °C (30 minutes) to +125 °C (30 minutes); 5 cycles | No visible damage Central Freq. Change ± 6% |
| 4.14 | Ca | Damp heat | 500 ± 12 hours at 60 °C; 90 to 95 % RH | No visible damage 2 hours recovery Central Freq. Change ± 6% |
| 4.15 | | Endurance | 500 ± 12 hours at 125 °C; | No visible damage 2 hours recovery Central Freq. Change ±6% |

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ORDERING INFORMATION: 12NC Ordering Code

The antennas may be ordered by using the 12 NC ordering code. These code numbers can be determined by the following rules:

F. Family Code

43 = Antenna

C. Packing Type Code

13 = Bulk, 1000 pcs

11 = 1000 pcs in tape

M. Materials Code

1 = High Frequency Material

S. Size Code

19 = 16.5 * 14 * 0.9 mm

T. Tolerance

00 = 80 M Hz Band Width

A. Working Frequency

 $087 = 850 \sim 950 \text{MHz}$

Example: 12NC 4311 119 00087

Product description: Antenna (43) by 1000 pcs (11) of High Frequency

Material (1), Size 16.5*14*0.9 mm (19);

Tolerance (00) of 80 MHz (VSWR<2)

Working Frequency $(087) = 870 \sim 950 \text{MHz}$

ORDERING INFORMATION: Method II- by Clear Text Code (Temporary)

The antennas may be ordered by using the 16-digit clear text ordering code. These code numbers can be determined by the following rules:

| | AN0870000716141B (Clear Text Code Example) | | | | | | | |
|---------|--|-----------|----------|-------------|------------|----------|--|--|
| AN | 0870 | 00 | 07 | 1614 | 1 | В | | |
| Product | Central Freq. | Bandwidth | Material | Size | Quantities | Packing | | |
| AN= | 0870=870MHz | 00=80MHz | 07=K7 | 1614=16*14* | 1 = 1K | B = Bulk | | |
| Antenna | ~ 950MHz | | | 0.9 mm | | | | |
| | | | | | | | | |
| | | | | | | | | |
| | | | | | | | | |

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Revision Control:

| Revision | Date | Content | Remark | |
|----------|----------------|---|--------|--|
| | March 13, 2002 | New Issued | | |
| | Oct. 14, 2002 | Modify dimension and termination width (S1, F, C, S2) | | |

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